





MSD10065G1

Automotive 650V Silicon Carbide Schottky Diode

Features

- -650-Volt Schottky Rectifier
- -Shorter recovery time
- -High-speed switching possible
- -High-Frequency Operation
- -Temperature-Independent Switching Behavior
- -Extremely Fast Switching
- -Positive Temperature Coefficient on VF

Benefits

- -Higher safety margin against overvoltage
- -Improved efficiency all load conditions
- -Increased efficiency compared to Silicon Diode alternatives
- -Reduction of Heat Sink Requirements
- -Parallel Devices Without Thermal Runaway
- -Essentialy No Switching Losses

Applications

- -Switch Mode Power Supplies
- -Power Factor Correction
- -Motor Drives
- -HID Lighting



Package

Type: TO-252

1、Cathode 2、Anode



Absolute Maximum Ratings

 T_C = 25°C unless otherwise noted

| Symbol | Parameter | MSD10065G1 | Units |
|-----------|--|-------------|-------|
| VRRM | Repetitive Peak Reverse Voltage | 650 | V |
| VRSM | Surge Peak Reverse Voltage | 650 | ٧ |
| VDC | DC Blocking Voltage | 650 | V |
| IF | Continuous Forward Current @Tc=150°C | 10 | Α |
| IFRM | Repetitive Peak Forward Surge Current @TC=25°C tp = 10 ms, Half Sine Wave | 80 | А |
| IFSM | Non-Repetitive Peak Forward Surge Current @TC=25°C tp= 10 ms, Half Sine Wave | 105 | А |
| IFSM | Non-Repetitive Peak Forward Surge Current @TC=25℃, tp= 10 us,pulse | 840 | А |
| Ptot | Power Dissipation @Tc=25°C @Tc=110°C | 138 60 | W |
| TJ , Tstg | Operating Junction and Storage Temperature | -55 to +175 | °C |

Electrical Characteristics

 T_C = 25 $^{\circ}$ C unless otherwise noted

| Symbol | Test Conditions | Test Conditions | Min | Тур | Max | Unit |
|--------|---------------------------|---|-----|-----------------|-------------|------|
| VF | Forward Voltage | IF=10A, TC=25° C IF=10A, TC=175° C | - | 1.45 1.75 | 1.7 2.00 | ٧ |
| IR | Reverse Current | VR=650V, TC=25° C VR=650V, TC=175° C | - | 2 40 | 20 200 | μΑ |
| QC | Total Capacitive Charge | VR =400V, IF =10A TJ = 25° C Qc= $\int_0^{v_c} C (V) dv$ | - | 28 | , | nC |
| С | Total Capacitance | VR =0V, TJ = 25° C, f=1MHz VR =200V, TJ = 25° C, f=1MHz VR =400V, TJ = 25° C, f=1MHz | - | 550 53 48 | - | pF |
| EC | Capacitance Stored Energy | VR=400V | - | 7.0 | - | μJ |

Thermal Characteristics

| Symbol | Parameter | Тур | Unit |
|--------|--|------|------|
| RθJC | Thermal Resistance from Junction to Case | 1.09 | °C/W |

Typical Characteristics

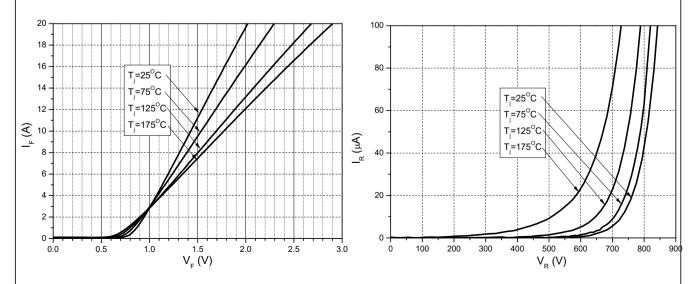
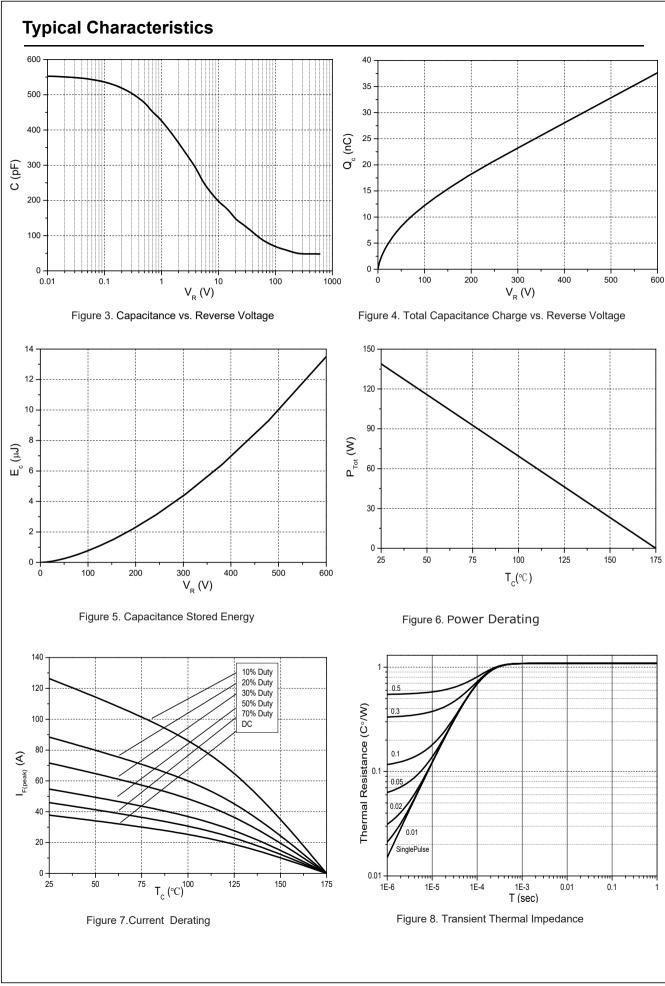
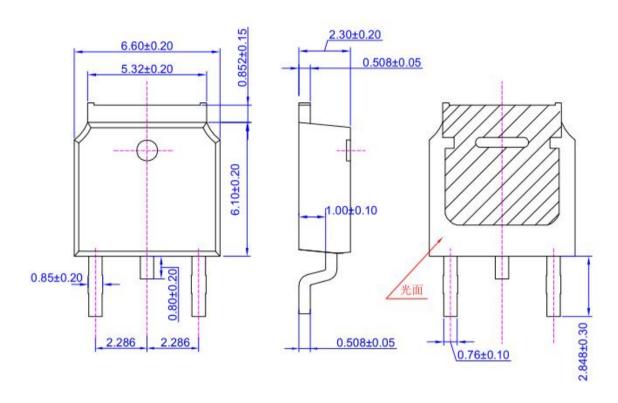


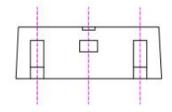
Figure 1.Forward Characteristics

Figure 2. Reverse Characteristics



TO-252 OUTLINE





NOTE:

1The plastic package is not marked as smooth surfaceRa=0.1; Subglossy surfaceRa=0.8 2. Undeclared tolerance \pm 0.25, Unmarked filletRmax=0.25

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